



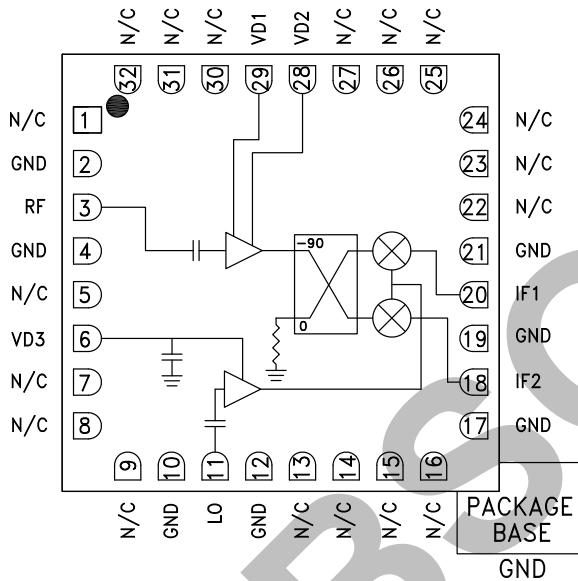
GaAs MMIC I/Q DOWNCONVERTER 12 - 16 GHz

Typical Applications

The HMC869LC5 is ideal for:

- Point-to-Point and Point-to-Multi-Point Radio
- Military Radar, EW & ELINT
- Satellite Communications

Functional Diagram



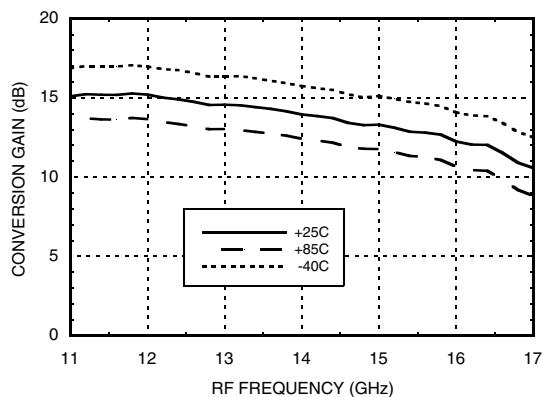
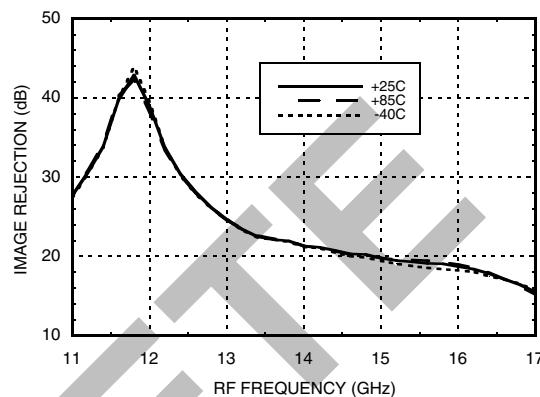
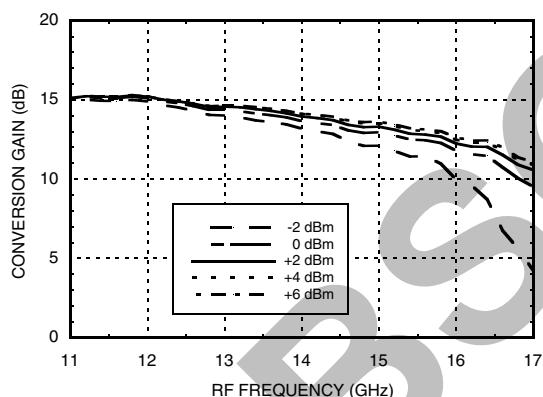
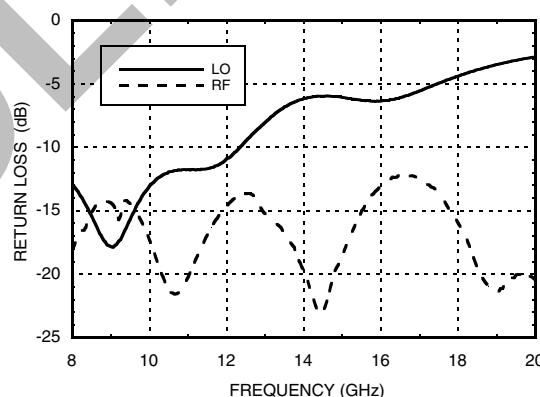
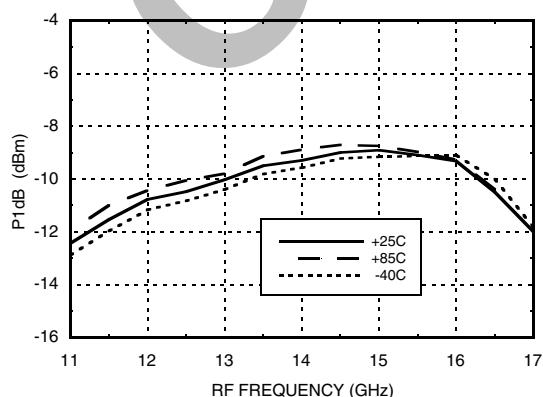
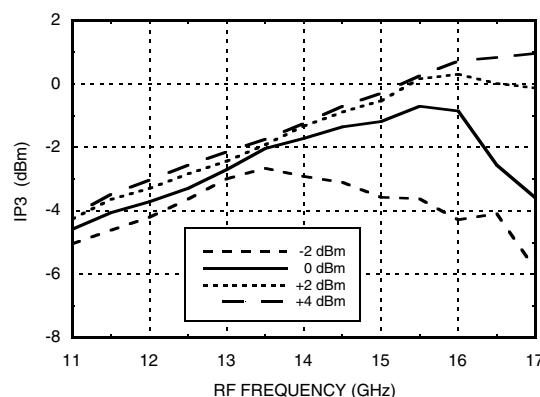
Electrical Specifications, $T_A = +25^\circ\text{C}$, IF = 100 MHz, LO = +2 dBm, VD3 = 5V, VD1, VD2 = 3V*

Parameter	Min.	Typ.	Max.	Units
Frequency Range, RF		12 - 16		GHz
Frequency Range, LO		8.5 - 19.5		GHz
Frequency Range, IF		DC - 3.5		GHz
Conversion Gain (As IRM)	10	14		dB
Noise Figure		2.8		dB
Image Rejection	15	32		dB
1 dB Compression (Input)		-10		dBm
LO to RF Isolation	30	45		dB
LO to IF Isolation	20	32		dB
IP3 (Input)		-1		dBm
Amplitude Balance		0		dB
Phase Balance		±10		Deg
Supply Current (ID1 + ID2)		60	88	mA
Supply Current (ID3)	100	120		mA

*Data taken as IRM with external 90° IF Hybrid


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Data Taken As IRM With External 90° IF Hybrid

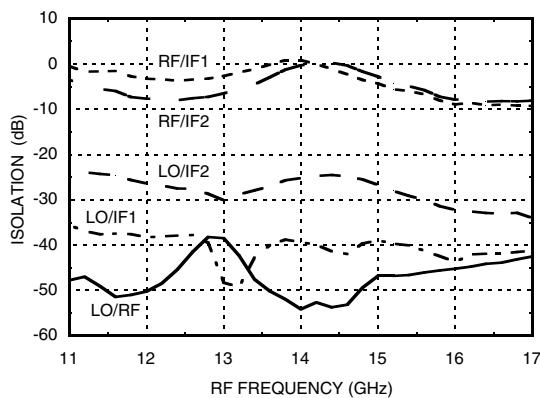
Conversion Gain vs. Temperature

Image Rejection vs. Temperature

Conversion Gain vs. LO Drive

Return Loss

Input P1dB vs. Temperature

Input IP3 vs. LO Drive




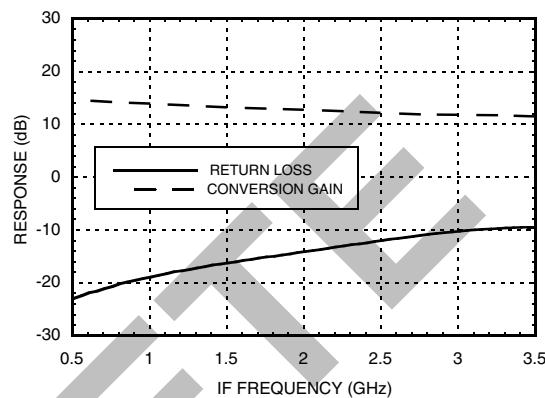
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Quadrature Channel Data Taken Without IF Hybrid

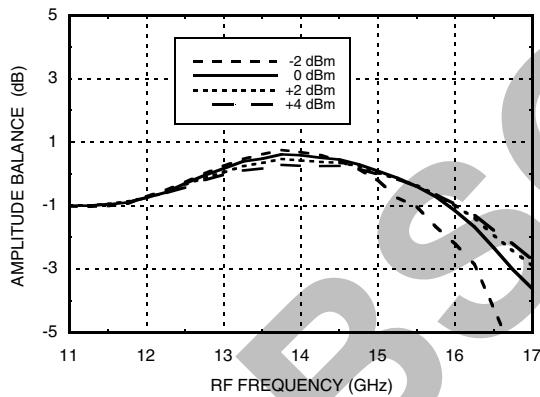
Isolations



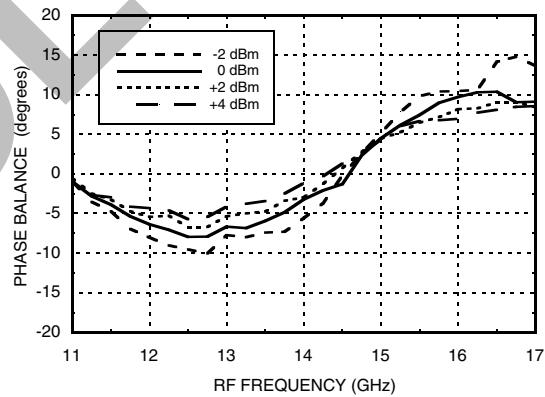
IF Bandwidth*



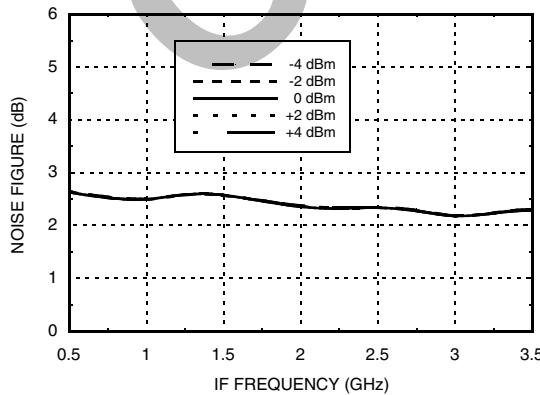
Amplitude Balance vs. LO Drive



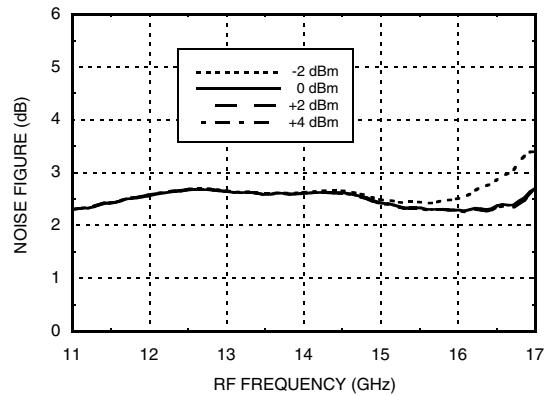
Phase Balance vs. LO Drive



Noise Figure vs. LO Drive, LO Frequency = 12 GHz



Noise Figure vs. LO Drive, IF Frequency = 100 MHz



* Conversion gain data taken with external IF hybrid, LO frequency fixed at 12 GHz and RF varied


MxN Spurious Outputs

	nLO				
mRF	0	1	2	3	4
0	xx	43	40	54	xx
1	22	xx	42	56	77
2	74	67	xx	74	98
3	99	97	73	xx	90
4	xx	104	120	102	xx

RF = 13.6 GHz @ -20 dBm
LO = 13.5 GHz @ +2 dBm
Data taken without IF hybrid
All values in dBc below IF power level.

**GaAs MMIC I/Q DOWNCONVERTER
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Absolute Maximum Ratings

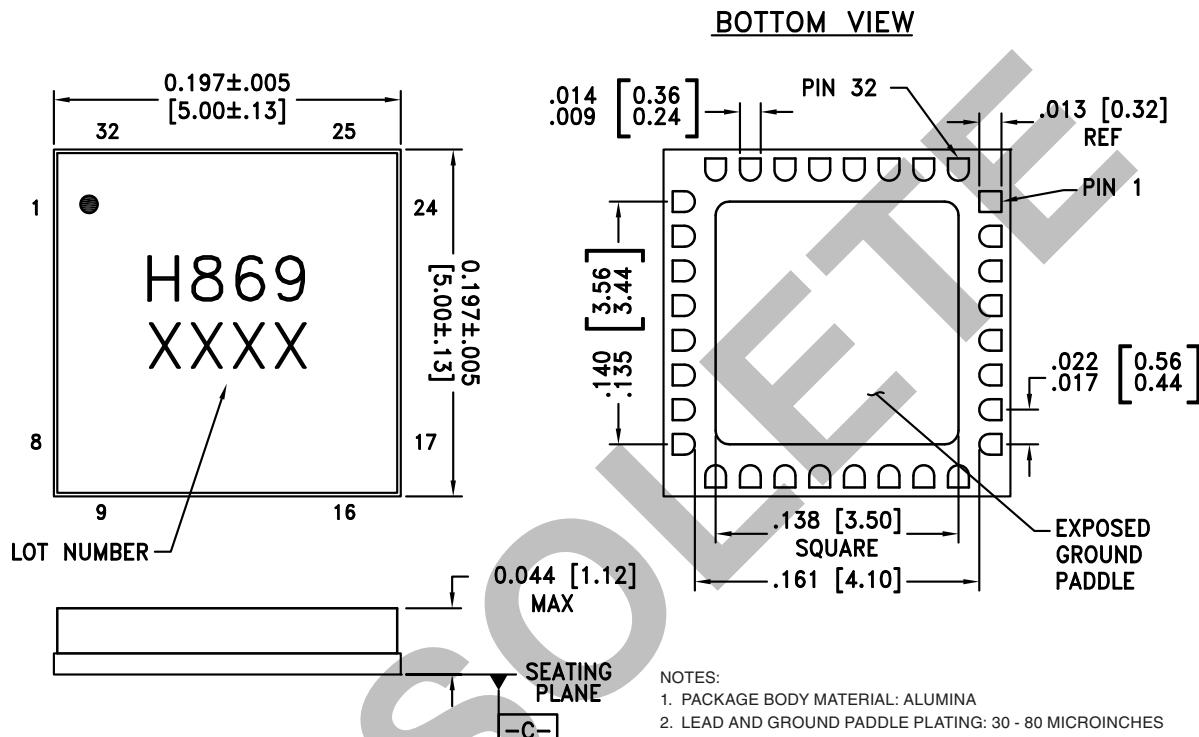
RF	+5 dBm
LO Drive	+20 dBm
VD1, VD2	4.0V
VD3	5.5V
Channel Temperature	150 °C
Continuous Pdiss (T=85°C) (derate 9.56 mW/°C above 85°C)	0.65 W
Thermal Resistance (R_{TH}) (channel to package bottom)	71 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C


**ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS**



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Outline Drawing



NOTES:

1. PACKAGE BODY MATERIAL: ALUMINA
2. LEAD AND GROUND PADDLE PLATING: 30 - 80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKLE
3. DIMENSIONS ARE IN INCHES [MILLIMETERS]
4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND

Package Information

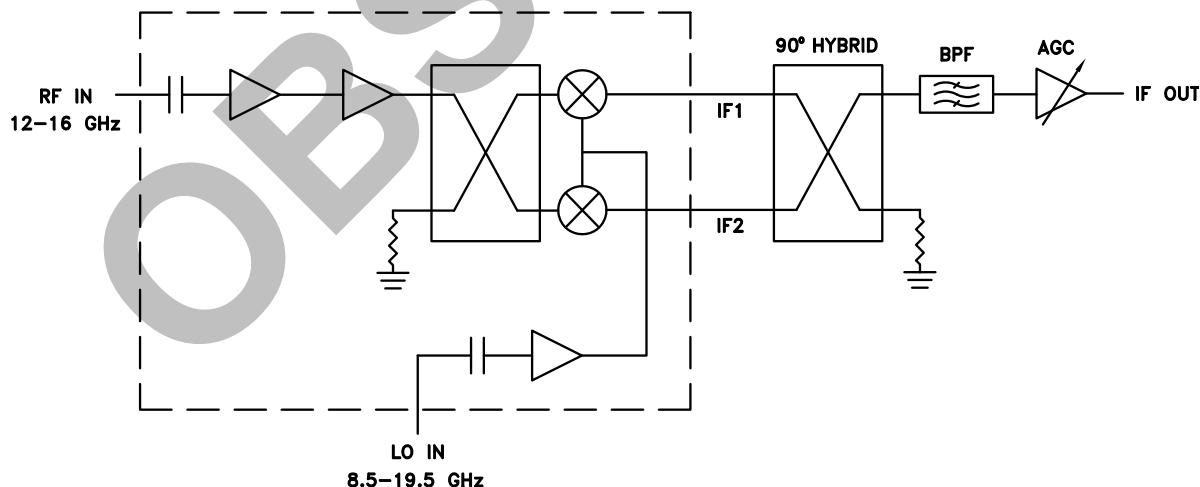
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[2]
HMC869LC5	Alumina, White	Gold over Nickel	MSL3 ^[1]	H869 XXXX

[1] Max peak reflow temperature of 260 °C

[2] 4-Digit lot number XXXX


**GaAs MMIC I/Q DOWNCONVERTER
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Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 5, 7 - 9, 13 - 16, 22 - 27, 30 - 32	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
2, 4, 10, 12, 17, 19, 21	GND	These pins and ground paddle must be connected to RF/DC ground.	
3	RF	This pin is AC coupled and matched to 50 Ohms.	
6	VD3	Power supply for LO amplifier.	
28, 29	VD2, VD1	Power supply for RF LNA.	
18	IF2	This pin is DC coupled for applications not requiring operation to DC. This port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary frequency range.	
20	IF1	For operation to DC, this pin must not sink / source more than 3 mA of current or part non-function and possible failure will result.	
11	LO	This pin is AC coupled and matched to 50 Ohms.	

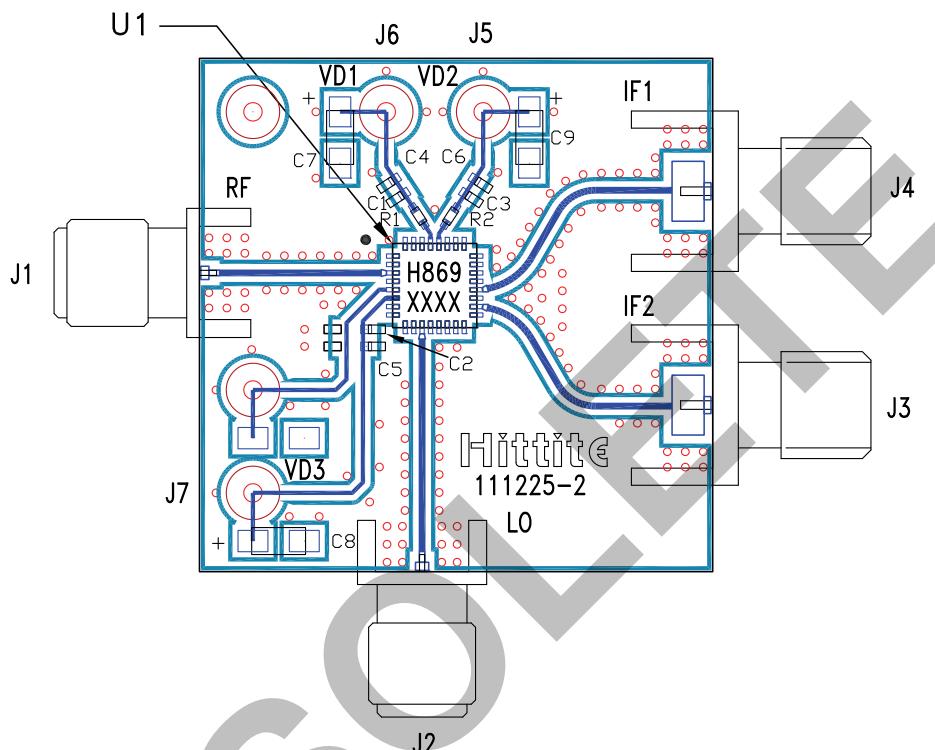
Typical Application


Note: LSB and USB is determined by GND on Hybrid



GaAs MMIC I/Q DOWNCONVERTER 12 - 16 GHz

Evaluation PCB



List of Materials for Evaluation PCB 111227^[1]

Item	Description
J1, J2	PCB Mount SMA RF Connector, SRI
J3, J4	PCB Mount SMA Connector, Johnson
J5, J6, J7	DC Pin
C1, C2, C3	Capacitor 0402, Pkg. 100pF
C4, C5, C6	Capacitor 0402, Pkg. 1000pF
C7, C8, C9	Capacitor, Case A, 2.2uF
R1, R2	Resistor, 0402 Pkg. 0 Ohm
U1	HMC869LC5
PCB [2]	111225 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350 or Arlon 25FR

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

**GaAs MMIC I/Q DOWNCONVERTER
12 - 16 GHz**

OBSOLETE

MIXERS - I/Q MIXERS, IRMS & RECEIVERS - SMT